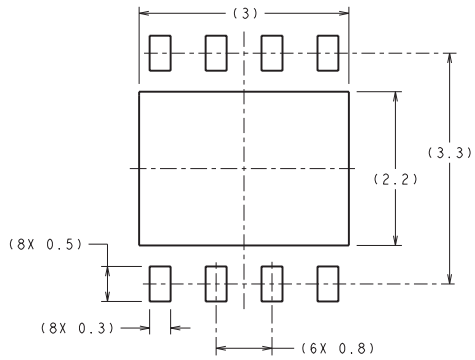
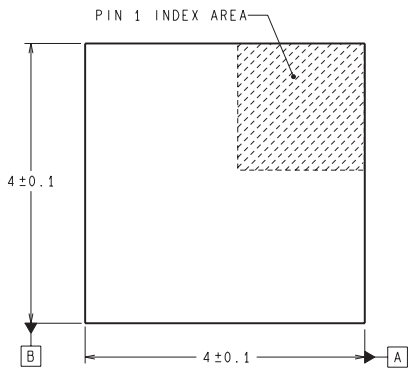


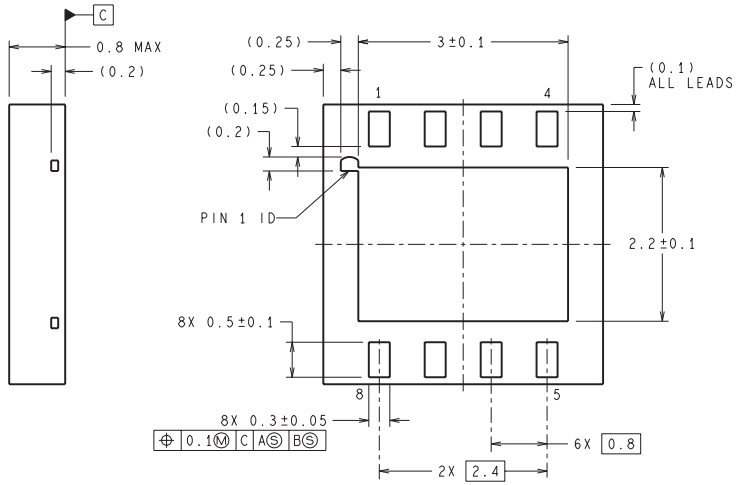
NGN0008A



RECOMMENDED LAND PATTERN
1:1 RATION WITH PKG SOLDER PADS



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LDC08A (Rev B)

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